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DS36C279 Low Power EIA-RS-485 Transceiver with Sleep Mode

General Description

The DS36C279 is a low power differential bus/line transceiver designed to meet the requirements of RS-485 Standard for multipoint data transmission. In addition it is compatible with TIA/EIA-422-B.

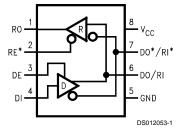
The sleep mode feature automatically puts the device in a power saving mode when both the driver and receiver are disabled.^{††} The device is ideal for use in power conscious applications where the device may be disabled for extended periods of time.

The driver and receiver outputs feature TRI-STATE® capability. The driver outputs operate over the entire common mode range of -7V to +12V. Bus contention or fault situations that cause excessive power dissipation within the device are handled by a thermal shutdown circuit, which forces the driver outputs into a high impedance state.

The receiver incorporates a fail safe circuit which guarantees a high output state when the inputs are left open.†

The DS36C279T is fully specified over the industrial temperature range (-40° C to $+85^{\circ}$ C).

Connection and Logic Diagram



Order Number DS36C279M, DS36C279TM See NS Package Number M08A

Features

- 100% RS-485 compliant
 Guaranteed RS-485 device interoperation
- Low power CMOS design: I_{CC} 500 µA max
- Automatic sensing sleep mode
- Reduces I_{CC} to 10 µA maximum
 Built-in power up/down glitch-free circuitry
- Permits live transceiver intersection/displacement
 SOIC packages
- SOIC packages
- Industrial temperature range: -40°C to +85°C
- On-board thermal shutdown circuitry
- Prevents damage to the device in the event of excessive power dissipation
- Wide common mode range: -7V to +12V
- Receive open input fail-safe (Note 1)
- 1/4 unit load (DS36C279): ≥ 128 nodes
- 1/2 unit load (DS36C279T): ≥ 64 nodes
- ESD (Human Body Model): ≥ 2 kV
- Drop-in replacement for:
 - LTC485 MAX485 DS75176 DS3695

DRIVER SECTION									
RE*	DE	DI	DO/RI	DO*/RI*					
Х	Н	Н	Н	L					
X	н	L	н						
X	L	Х	Z	Z					
RECEIV	ER SECT	ION							
RE*	DE	R	I-RI*	RO					
L	L	≥-	+0.2V	Н					
L	L	≤–0.2V		L					
н	L	Х		Z (Note 2)					
L	L	OPEN	I (Note 1)	н					

Note 1: Non-terminated, open input only

Note 2: Device enters sleep mode if enable conditions are held 600 ns

TRI-STATE® is a registered trademark of National Semiconductor Corporation.

Absolute Maximum Ratings (Note 3)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage (V _{CC})	+12V				
Input Voltage (DE, RE*, & DI)	–0.5V to (V _{CC} +0.5V)				
Common Mode (V _{CM})					
Driver Output/Receiver Input	±15V				
Input Voltage (DO/RI, DO*/RI*)	±14V				
Receiver Output Voltage	–0.5V to (V _{CC} +0.5V)				
Maximum Package Power Dissipa	ation				
@ +25°C					
M Package 1190 mW, derate	9.5 mW/°C above +25°C				
Storage Temperature Range	-65°C to +150°C				

Lead Temperature (Soldering 4 sec)

+260°C

Recommended Operating Conditions

	Min	Тур	Мах	Units		
Supply Voltage (V_{CC})	+4.75	+5.0	+5.25	V		
Bus Voltage	-7		+12	V		
Operating Free Air Tem	Air Temperature (T _A)					
DS36C279T	-40	+25	+85	°C		
DS36C279	0	+25	+70	°C		

Electrical Characteristics (Notes 4, 5)

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified

Symbol	Parameter	Condition	S	Reference		Min	Тур	Max	Units
DIFFER	ENTIAL DRIVER CHARACTE	RISTICS					•		
V _{OD1}	Differential Output Voltage	I _O = 0 mA (No Load)		(-	422)	1.5		5.0	V
V _{OD0}	Output Voltage	$I_{O} = 0 \text{ mA}$		(485)		0		5.0	V
V _{OD0*}	Output Voltage	(Output to GND)						5.0	V
V _{OD2}	Differential Output Voltage	$R_L = 50\Omega$		(422)	Figure 1	2.0	2.8		V
	(Termination Load)	$R_L = 27\Omega$		(485)		1.5	2.3	5.0	V
ΔV_{OD2}	Balance of V _{OD2}	$R_L = 27\Omega \text{ or } 50\Omega$		(N	ote 6)	-0.2	0.1	+0.2	V
	V _{OD2} – V _{OD2*}			(42)	2, 485)				
V _{OD3}	Differential Output Voltage	R1 = 54Ω, R2 = 375Ω		Fig	gure 2	1.5	2.0	5.0	V
	(Full Load)	$V_{\text{TEST}} = -7V \text{ to } +12V$							
V _{oc}	Driver Common Mode	$R_L = 27\Omega$		(485)	Figure 1	0		3.0	V
	Output Voltage	$R_L = 50\Omega$		(422)		0		3.0	V
ΔV_{OC}	Balance of V _{OC}	$R_L = 27\Omega \text{ or}$		(N	ote 6)	-0.2		+0.2	V
	V _{oc} - V _{oc*}	$R_L = 50\Omega$		(42)	(422, 485)				
I _{OSD}	Driver Output Short-Circuit	V _O = +12V		(485) Figure 4			200	+250	mA
	Current	$V_{O} = -7V$		(•	485)		-190	-250	mA
RECEIV	ER CHARACTERISTICS								
V _{TH}	Differential Input High	$V_{O} = V_{OH}, I_{O} = -0.4 \text{ n}$	۱A				+0.035	+0.2	V
	Threshold Voltage	$-7V \le V_{CM} \le +12V$	(Note 7)						
V _{TL}	Differential Input Low	$V_{\rm O} = V_{\rm OL}, \ I_{\rm O} = 0.4 \ \text{mA}$	٨	(42)	2, 485)	-0.2	-0.035		V
	Threshold Voltage	$-7V \le V_{CM} \le +12V$							
V _{HST}	Hysteresis	$V_{CM} = 0V$		(Note 8)			70		mV
R _{IN}	Input Resistance	$-7V \le V_{CM} \le +12V$	DS36C279T			24	68		kΩ
			DS36C279			48	68		kΩ
I _{IN}	Line Input Current	Other Input = 0V,	DS36C279	V _{IN}	= +12V	0	0.19	0.25	mA
	(Note 9)	$DE = V_{IL}, RE^* = V_{IL},$		V _{IN}	= -7V	0	-0.1	-0.2	mA
		V _{CC} = 4.75 to 5.25	DS36C279T	V _{IN}	= +12V	0	0.19	0.5	mA
		or 0V		$V_{IN} = -7V$		0	-0.1	-0.4	mA
I _{ING}	Line Input Current Glitch	Other Input = 0V,	DS36C279	V _{IN}	= +12V	0	0.19	0.25	mA
	(Note 9)	$DE = V_{IL}, RE^* = V_{IL},$		V _{IN}	= -7V	0	-0.1	-0.2	mA
		$V_{\rm CC}$ = +3.0V or 0V,	DS36C279T	V _{IN}	= +12V	0	0.19	0.5	mA
		$T_A = 25^{\circ}C$		V _{IN}	= -7V	0	-0.1	-0.4	mA
I _B	Input Balance Test	RS = 500Ω		(422)	(Note 12)			±400	mV
V _{OH}	High Level Output Voltage	$I_{OH} = -4 \text{ mA}, V_{ID} = +0$	0.2V		RO	3.5	4.6		V
V _{OL}	Low Level Output Voltage	$I_{OL} = +4 \text{ mA}, V_{ID} = -0$.2V	Fig	ure 11		0.3	0.5	V

DS36C279 Low

Electrical Characteristics (Notes 4, 5) (Continued)

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified

Symbol	Parameter	Conditions	6	Reference	Min	Тур	Max	Units
RECEIV	ER CHARACTERISTICS							
I _{OSR}	Short Circuit Current	V _O = GND		RO	7	35	85	mA
I _{OZR}	TRI-STATE Leakage	$V_{\rm O} = 0.4$ V to 2.4V					±1	μA
	Current							
DEVICE	CHARACTERISTICS	•						
V _{IH}	High Level Input Voltage			DE,	2.0		V _{cc}	V
VIL	Low Level Input Voltage			RE*,	GND		0.8	V
I _{IH}	High Level Input Current	$V_{IH} = V_{CC}$		DI			2	μA
I_{IL}	Low Level Input Current	$V_{\rm CC} = 5V$	$V_{IL} = 0V$				-2	μA
		$V_{\rm CC} = +3.0V$					-2	μA
I _{CC}	Power Supply Current	Driver and Receiver Of	N			200	500	μA
I _{CCR}	(No Load)	Driver OFF, Receiver O	DN	V		200	500	μA
I _{CCD}	1	Driver ON, Receiver O	FF	V _{cc}		200	500	μA
I _{ccx}	1	Sleep Mode				0.2	10	μA

Switching Characteristics (Notes 5, 10) Over Supply Voltage and Operating Temperature ranges, unless otherwise specified

Symbol	Parameter	Conditions	Reference	Min	Тур	Max	Units
DRIVER (CHARACTERISTICS		1				
t _{PHLD}	Differential Propagation Delay High to Low	$R_{L} = 54\Omega, \ C_{L} = 100 \ pF$		10	39	80	ns
t _{PLHD}	Differential Propagation Delay Low to High		5. 5.0	10	40	80	ns
t _{skd}	Differential Skew	_	Figures 5, 6	0	1	10	ns
	t _{PHLD} – t _{PLHD}						
t _r	Rise Time			3	25	50	ns
t _f	Fall Time			3	25	50	ns
t _{PHZ}	Disable Time High to Z	C _L = 15 pF	Figures 7, 8		80	200	ns
t _{PLZ}	Disable Time Low to Z	RE* = L	Figures 9, 10		80	200	ns
t _{PZH}	Enable Time Z to High	C _L = 100 pF	Figures 7, 8		50	200	ns
t _{PZL}	Enable Time Z to Low	RE* = L	Figures 9, 10		65	200	ns
t _{PSH}	Driver Enable from Sleep	C _L = 100 pF	Figures 7, 8	70	98	250	ns
	Mode to Output High	(Note 11)					
t _{PSL}	Driver Enble from Sleep	C _L = 100 pF	Figures 9, 10	70	98	250	ns
	Mode to Output Low	(Note 11)					
RECEIVE	R CHARACTERISTICS	·	•				
t _{PHL}	Propagation Delay	C _L = 15 pF	Figures 12, 13	30	210	400	ns
	High to Low						
t _{PLH}	Propagation Delay			30	190	400	ns
	Low to High						
t _{sk}	Skew, t _{PHL} – t _{PLH}			0	20	50	ns
t _{PLZ}	Output Disable Time	C _L = 15 pF			50	150	ns
t _{PHZ}	1	DE = H	Figures 14, 15,		55	150	ns
t _{PZL}	Output Enable Time		16		40	150	ns
t _{PZH}					45	150	ns
t _{PSH}	Receiver Enable from Sleep	C _L = 15 pF	Figures 14, 16	70	97	250	ns
	Mode to Output High	(Note 11)					
t _{PSL}	Receiver Enable from Sleep	C _L = 15 pF	Figures 14, 15	70	95	250	ns

Switching Characteristics (Notes 5, 10) (Continued)

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified

Symbol	Parameter	Conditions	Reference	Min	Тур	Max	Units	
RECEIVER CHARACTERISTICS								
	Mode to Output Low	(Note 11)						

Note 3: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" specifies conditions of device operation.

Note 4: Current into device pins is defined as positive. Current out of device pins is defined as negative. All voltages are referenced to ground except V_{OD1} and V_{OD2} . **Note 5:** All typicals are given for: V_{CC} = +5.0V, T_A = + 25°C.

Note 6: Delta $|V_{OD2}|$ and Delta $|V_{OC}|$ are changes in magnitude of V_{OD2} and V_{OC} , respectively, that occur when input changes state.

Note 7: Threshold parameter limits specified as an algebraic value rather than by magnitude.

Note 8: Hysteresis defined as $V_{HST} = V_{TH} - V_{TL}$.

Note 9: I_{IN} includes the receiver input current and driver TRI-STATE leakage current.

Note 10: C_L includes probe and jig capacitance.

Note 11: For enable from sleep mode delays DE = L and RE* = H for greater than 600 ns prior to test (device is in sleep mode).

Note 12: For complete details of test, see RS-485.

Parameter Measurement Information

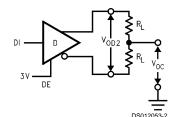


FIGURE 1. Driver V_{OD2} and V_{OC}

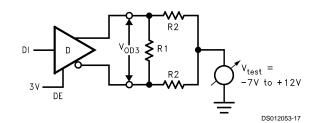


FIGURE 2. Driver VOD3

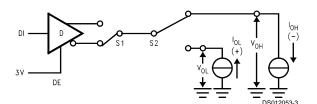
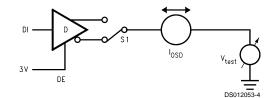


FIGURE 3. Driver V_{OH} and V_{OL}



Vtest = -7V to +12V

FIGURE 4. Driver IOSD

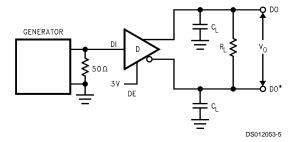


FIGURE 5. Driver Differential Propagation Delay Test Circuit

Parameter Measurement Information (Continued)

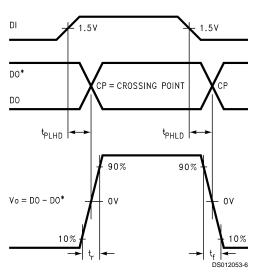
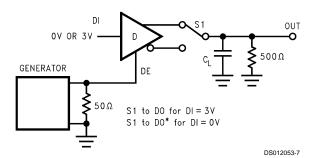
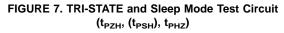
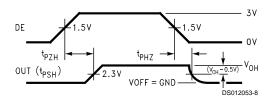
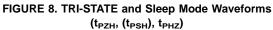


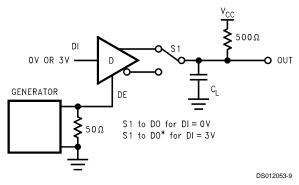
FIGURE 6. Driver Differential Propagation Delays and Differential Rise and Fall Times

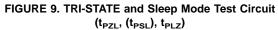












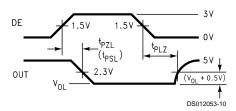


FIGURE 10. TRI-STATE and Sleep Mode Waveforms $(t_{PZL}, (t_{PSL}), t_{PLZ})$

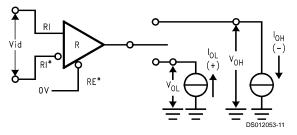


FIGURE 11. Receiver V_{OH} and V_{OL}

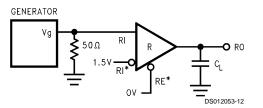


FIGURE 12. Receiver Differential Propagation Delay Test Circuit

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Parameter Measurement Information (Continued)

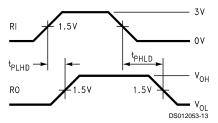


FIGURE 13. Receiver Differential Propagation Delay Waveforms

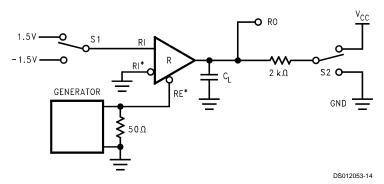


FIGURE 14. Receiver TRI-STATE and Sleep Mode Test Circuit

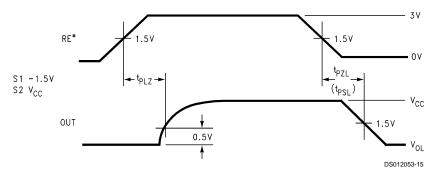


FIGURE 15. Receiver Enable and Disable Waveforms (t_{PLZ} , t_{PZL} , (t_{PSL}))

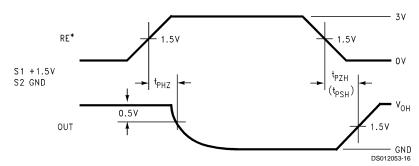
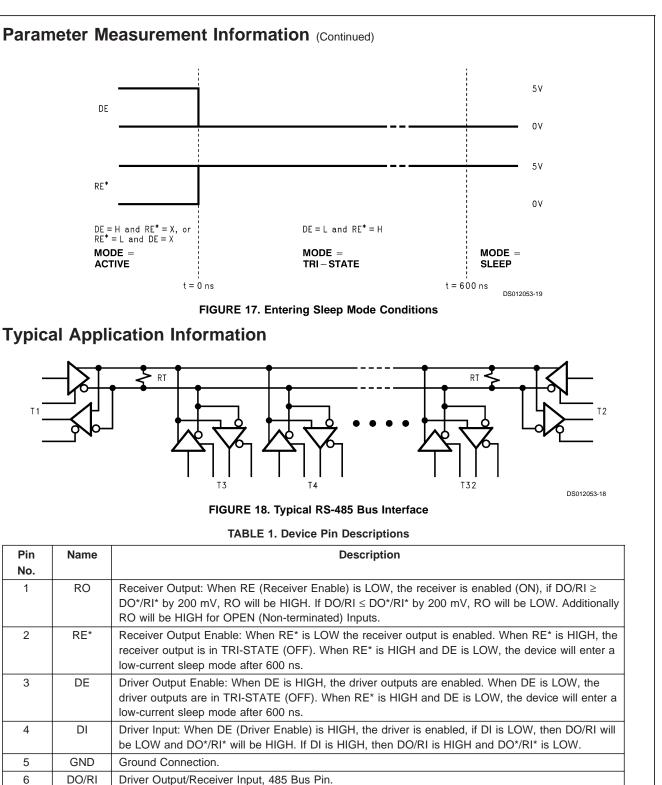


FIGURE 16. Receiver Enable and Disable Waveforms (t_{PHZ} , t_{PZH} , (t_{PSH}))



Positive Power Supply Connection: Recommended operating range for V_{CC} is +4.75V to +5.25V.

Unit Load

DO*/RI*

Vcc

7

8

A unit load for an RS-485 receiver is defined by the input current versus the input voltage curve. The gray shaded region is the defined operating range from -7V to +12V. The top border extending from -3V at 0 mA to +12V at +1 mA is defined as one unit load. Likewise, the bottom border extending from +5V at 0 mA to -7V at -0.8 mA is also defined as one

Driver Output/Receiver Input, 485 Bus Pin.

unit load (see *Figure 19*). An RS-485 driver is capable of driving up to 32 unit loads. This allows up to 32 nodes on a single bus. Although sufficient for many applications, it is sometimes desirable to have even more nodes. For example, an aircraft that has 32 rows with 4 seats per row would benefit from having 128 nodes on one bus. This would

DS36C279 Low

Unit Load (Continued)

allow signals to be transferred to and from each individual seat to 1 main station. Usually there is one or two less seats in the last row of the aircraft near the restrooms and food storage area. This frees the node for the main station.

The DS36C278, the DS36C279, and the DS36C280 all have $\frac{1}{2}$ unit load and $\frac{1}{4}$ unit load (UL) options available. These devices will allow up to 64 nodes or 128 nodes guaranteed over temperature depending upon which option is selected. The $\frac{1}{2}$ UL option is available in industrial temperature and the $\frac{1}{4}$ UL is available in commercial temperature.

First, for a $\frac{1}{2}$ UL device the top and bottom borders shown in *Figure 19* are scaled. Both 0 mA reference points at +5V and -3V stay the same. The other reference points are +12V at +0.5 mA for the top border and -7V at -0.4 mA for the bottom border (see *Figure 19*). Second, for a $\frac{1}{4}$ UL device the top and bottom borders shown in *Figure 19* are scaled also. Again, both 0 mA reference points at +5V and -3V stay the same. The other reference points are +12V at +0.25 mA for the top border and -7V at -0.2 mA for the bottom border (see *Figure 19*).

The advantage of the $\frac{1}{2}$ UL and $\frac{1}{4}$ UL devices is the increased number of nodes on one bus. In a single master multi-slave type of application where the number of slaves exceeds 32, the DS36C278/279/280 may save in the cost of extra devices like repeaters, extra media like cable, and/or extra components like resistors.

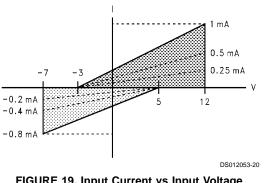


FIGURE 19. Input Current vs Input Voltage Operating Range

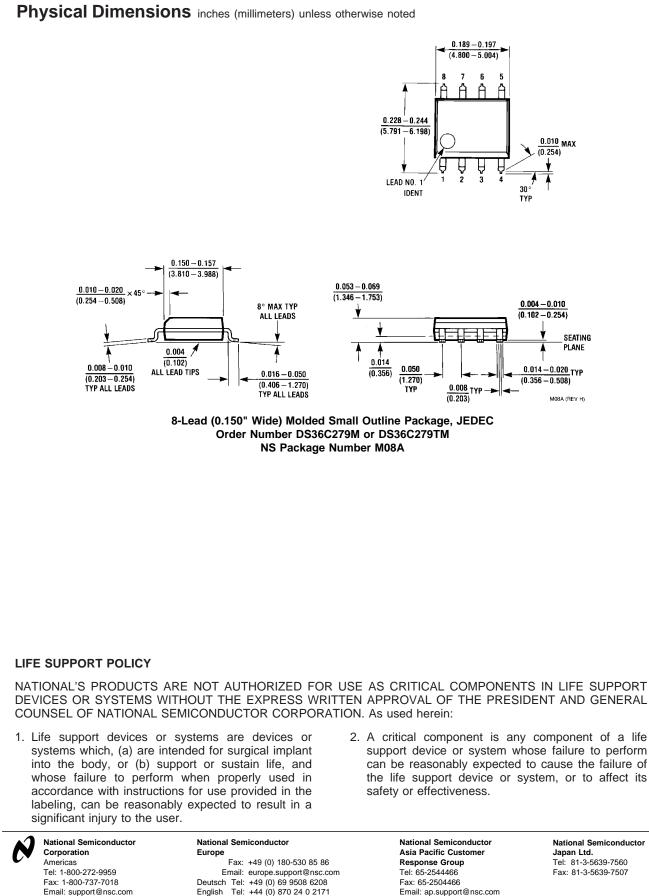
The DS36C279 and DS36C280 have an additional feature which offers more advantages. The DS36C279 has an automatic sleep mode function for power conscious applications. The DS36C280 has a slew rate control for EMI conscious applications. Refer to the sleep mode and slew rate control portion of the application information section in the corresponding datasheet for more information on these features.

Sleep Mode

The DS36C279 features an automatic shutdown mode that allows the device to save power when not transmitting data. Since the shutdown mode is automatic, no external components are required. It may be used as little or as much as the application requires. The more the feature is utilized, the more power it saves.

The sleep mode is automatically entered when both the driver and receiver are disabled. This occurs when both the DE pin is asserted to a logic low and the RE* pin is asserted to a logic high. Once both pins are asserted the device will enter sleep mode typically in 50 ns. The DS36C279 is guaranteed to go into sleep mode within 600 ns after both pins are asserted. The device wakes up (comes out of sleep mode) when either the DE pin is asserted to a logic high and/or the RE* pin is asserted to a logic low. After the device enters sleep mode it will take longer for the device to wake up than it does for the device to enable from TRI-STATE. Refer to datasheet specifications t_{PSL} and t_{PSH} and compare with t_{PZL} and t_{PZH} for timing differences.

The benefit of the DS36C279 is definitely its power savings. When active the device has a maximum $I_{\rm CC}$ of 500 $\mu A.$ When in sleep mode the device has a maximum $I_{\rm CC}$ of only 10 $\mu A,$ which is 50 times less power than when active. The $I_{\rm CC}$ when the device is active is already very low but when in sleep mode the $I_{\rm CC}$ is ultra low.



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